

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6755232

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	YACOV SALOMON	06/08/2021
	SETH YATES	06/08/2021
	MAXWELL ANDERSON	06/08/2021
	VIVEK VAIDYA	06/08/2021
	ANTON WINTER	06/08/2021
	SAMUEL ALEXANDER	06/10/2021
	TOM CHAVEZ	06/08/2021
RECEIVING PARTY DATA		
Name:	KETCH KLOUD, INC.	
Street Address:	23 GEARY STREET	
Internal Address:	SUITE 600	
City:	SAN FRANCISCO	
State/Country:	CALIFORNIA	
Postal Code:	94108	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	17339780	
CORRESPONDENCE DATA		
Fax Number:	(303)473-2720	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	3034732700	
Email:	cesimon@hollandhart.com	
Correspondent Name:	NATHAN J. MUTTER	
Address Line 1:	P.O. BOX 11583	
Address Line 4:	SALT LAKE CITY, UTAH 84147	
ATTORNEY DOCKET NUMBER:	P002.01.01 (105310.0007)	
NAME OF SUBMITTER:	NATHAN J. MUTTER	
SIGNATURE:	/Nathan J. Mutter/	

DATE SIGNED:	06/10/2021
Total Attachments: 3 source=P002.01.01 Assignment Ketch Kloud#page1.tif source=P002.01.01 Assignment Ketch Kloud#page2.tif source=P002.01.01 Assignment Ketch Kloud#page3.tif	

ASSIGNMENT

WHEREAS, WE,

1. Yacov Salomon, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,
2. Seth Yates, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,
3. Maxwell Anderson, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,
4. Anton Winter, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,
5. Samuel Alexander, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,
6. Vivek Vaidya, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,
7. Tom Chavez, having a mailing address located at 23 Geary Street, Suite 600, San Francisco, CA 94108,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to DATA PROCESSING PERMITS SYSTEM WITH KEYS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **Ketch Kloud, Inc.** (hereinafter "ASSIGNEE"), having a place of business at 23 Geary Street, Suite 600, San Francisco, CA 94108, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we do hereby acknowledge that we have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/339,780 filed June 4, 2021, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application

number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND we further do acknowledge and agree that we have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which I may be entitled, or that I may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that we will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to me respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that we will not execute any writing or do any act whatsoever conflicting with these presents.

PATENT

Attorney Ref. No.: P002.01.01 (105310.0007)

Page 3 of 3

Done at _____, on 6/8/2021
City, State Date

DocuSigned by:



23898243FFC0F4D3

Yacov SALOMON

Done at _____, on 6/8/2021
City, State Date

DocuSigned by:

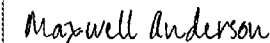


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Seth YATES

Done at _____, on 6/8/2021
City, State Date

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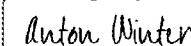


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Maxwell ANDERSON

Done at _____, on 6/8/2021
City, State Date

DocuSigned by:



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Anton WINTER

Done at _____, on 6/10/2021
City, State Date

DocuSigned by:

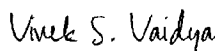


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Samuel ALEXANDER

Done at _____, on 6/8/2021
City, State Date

DocuSigned by:



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Vivek VAIDYA

Done at _____, on 6/8/2021
City, State Date

DocuSigned by:



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Tom CHAVEZ